





HIGH VOLTAGE SWITCHING DIODE

Features

- Fast Switching Speed: Maximum of 50ns
- High Reverse Breakdown Voltage: 325V
- Low Leakage Current: Maximum of 50nA when V_R = 5V or Maximum of 150nA when V_R = 250V at Room Temperature
- Ultra Small Plastic SMD Package: 1.0mm x 0.6mm x 0.5mm
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: X1-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (4)
- Weight: 0.0009 grams (Approximate)

X1-DFN1006-2







Device Schematic

Ordering Information (Note 5)

Part Number	Qualification	Case	Packaging
BAS521LPQ-7B	Automotive	X1-DFN1006-2	10.000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q10x qualified and are PPAP capable. Refer to https://www.diodes.com/quality/
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

BAS521LP-7B

98

Top View Bar Denotes Cathode Side 98 = Product Type Marking Code



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	325	V
Working Peak Reverse Voltage DC Blocking Voltage	V _{RWM} V _R	325	V
Forward Current (Note 6)	I _F	400	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0µs	I _{FSM}	8.0	Α
Repetitive Peak Forward Current @ t=8.3ms	I _{FRM}	3.0	A

Thermal Characteristics

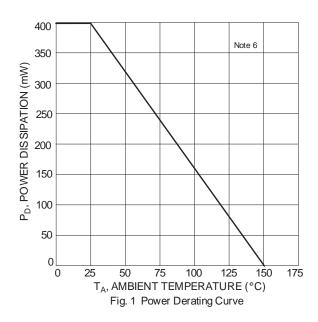
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P_{D}	400	mW
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{ hetaJA}$	312	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

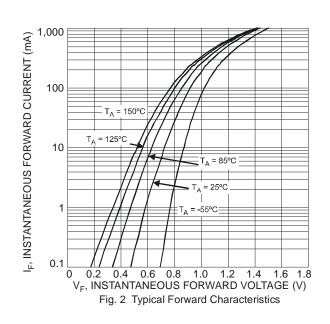
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	300	_	V	$I_R = 100 \mu A$
Forward Voltage	V _F	_	1.1	V	I _F = 100mA
Reverse Current (Note 7)	I _R	_	50 150 100	nA nA	$V_R = 5V$ $V_R = 250V$
Total Capacitance	СТ		5	μA pF	$V_R = 250V, T_J = +150$ °C $V_R = 0, f = 1.0MHz$
Reverse Recovery Time	t _{rr}	_	50	ns	$I_F = I_R = 30 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

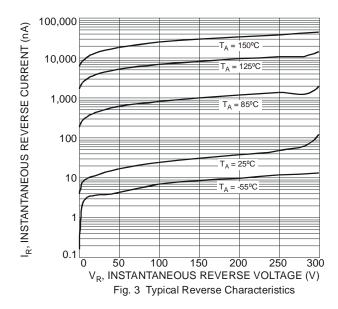
Notes:

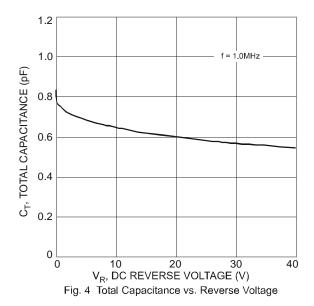
- 6. Part is mounted on a FR-7 substrate PC board, with 1" x 1" 2oz copper pad.
- 7. Short duration pulse test used to minimize self-heating effect.





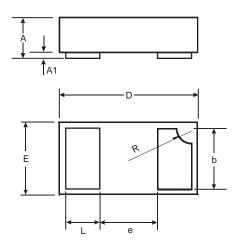






Package Outline Dimensions

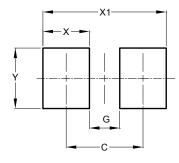
Please see http://www.diodes.com/package-outlines.html for the latest version.



X1-DFN1006-2					
Dim	Min	Max	Тур		
Α	0.47	0.53	0.50		
A1	0	0.05	0.03		
b	0.45	0.55	0.50		
D	0.95	1.075	1.00		
Е	0.55	0.675	0.60		
е	-	-	0.40		
L	0.20	0.30	0.25		
R	0.05	0.15	0.10		
All	All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)		
С	0.70		
G	0.30		
Х	0.40		
X1	1.10		
Υ	0.70		



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